

### T2800D



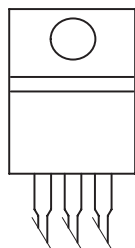
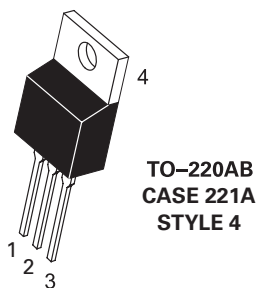
#### Description

Designed primarily for full-wave ac control applications, such as light dimmers, motor controls, heating controls and power supplies.

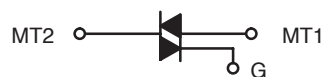
#### Features

- Blocking Voltage to 400 V
- All Diffused and Glass Passivated Junctions for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Four Quadrant Gating
- Pb-Free Package is Available

#### Pin Out



#### Functional Diagram



#### Additional Information



**Datasheet**



**Resources**



**Samples**

### Maximum Ratings ( $T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) (Sine Wave 50 to 60 Hz, $T_J = -40$ to $+100^\circ\text{C}$ , Gate Open)	$V_{\text{DRM}}$ $V_{\text{RRM}}$	400	V
On-State RMS Current (All Conduction Angles, $T_C = +80^\circ\text{C}$ )	$I_{\text{T (RMS)}}$	6.0	A
Peak Non-Repetitive Surge Current (One Full Cycle, Sine Wave 60 Hz, $T_J = +80^\circ\text{C}$ )	$I_{\text{TSM}}$	100	A
Circuit Fusing Considerations ( $t = 8.3$ ms)	$I^2t$	40	A <sup>2</sup> s
Peak Gate Power (Pulse Width = 10 $\mu\text{sec}$ , $T_C = +80^\circ\text{C}$ )	$P_{\text{GM}}$	16	W
Average Gate Power ( $t = 8.3$ msec, $T_C = +80^\circ\text{C}$ )	$P_{\text{GM (AV)}}$	0.35	W
Peak Gate Current (Pulse Width = 10 $\mu\text{sec}$ , $T_C = +80^\circ\text{C}$ )	$I_{\text{GM}}$	4.0	A
Operating Junction Temperature Range @ Rated $V_{\text{RRM}}$ and $V_{\text{DRM}}$	$T_J$	-40 to +125	$^\circ\text{C}$
Storage Temperature Range	$T_{\text{stg}}$	-40 to +150	$^\circ\text{C}$

### Thermal Characteristics

Rating	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\text{JC}}$	2.2	$^\circ\text{C/W}$
Maximum Device Temperature for Soldering Purposes for 10 Sec	$T_L$	260	$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- $V_{\text{DRM}}$  and  $V_{\text{RRM}}$  for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

### Electrical Characteristics - OFF ( $T_J = 25^\circ\text{C}$ unless otherwise noted, Electricals apply in both directions)

Characteristic		Symbol	Min	Typ	Max	Unit
Peak Repetitive Forward or Reverse Blocking Current (Note 3) ( $V_D = \text{Rated } V_{\text{DRM}}, V_{\text{RRM}}, \text{Gate Open}$ )	$T_C = 25^\circ\text{C}$	$I_{\text{DRM}}$	–	–	10	$\mu\text{A}$
	$T_C = 100^\circ\text{C}$		–	–	2.0	mA

### Electrical Characteristics - ON ( $T_J = 25^\circ\text{C}$ unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Typ	Max	Unit
Peak Forward On-State Voltage (Note 3) ( $I_{\text{TM}} = \pm 30 \text{ A}$ )		$V_{\text{TM}}$	–	1.7	2.0	V
Gate Trigger Current (Continuous dc) ( $V_D = 12 \text{ V}, R_L = 100 \Omega$ )	MT2(+), G(+)	$I_{\text{GT}}$	–	10	25	mA
	MT2(+), G(–)		–	20	60	
	MT2(–), G(–)		–	15	25	
	MT2(–), G(+)		–	30	60	
Gate Trigger Voltage (Continuous dc) (All Four Quadrants) ( $V_D = 12 \text{ Vdc}, R_L = 100 \Omega$ )		$V_{\text{GT}}$	–	1.25	2.5	V
Gate Non-Trigger Voltage (Continuous dc) ( $V_D = 12 \text{ Vdc}, R_L = 100 \Omega, T_C = 100^\circ\text{C}$ )		$V_{\text{GD}}$	0.2	–	–	V
Holding Current (Main Terminal Voltage = 12 Vdc, Gate Open, Initiating Current) = $\pm 200 \text{ mA}$ )		$I_{\text{H}}$	–	15	30	mA
Gate Controlled Turn-On Time (Rated $V_{\text{DRM}}, I_T = 10 \text{ A}, I_{\text{GT}} = 160 \text{ mA}, \text{Rise Time} = 0.1 \mu\text{s}$ )		$t_{\text{gt}}$	–	1.6	–	$\mu\text{s}$

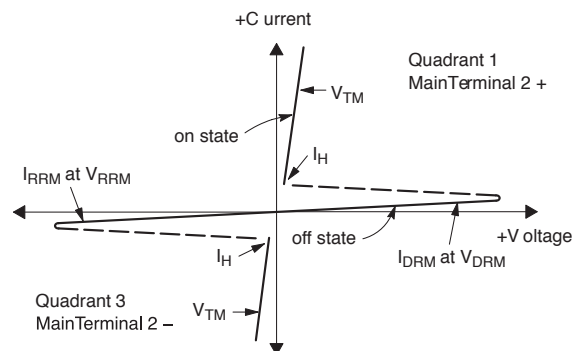
### Dynamic Characteristics

Characteristic	Symbol	Min	Typ	Max	Unit
Critical Rate-of-Rise of Commutation Voltage ( $V_D = \text{Rated } V_{\text{DRM}}, I_{\text{T(RMS)}} = 8 \text{ A}, \text{Commutating } di/dt = 4.1 \text{ A/ms}, \text{Gate Unenergized}, T_C = 80^\circ\text{C}$ )	$dv/dt$	–	10	–	$\text{V}/\mu\text{s}$
Critical Rate-of-Rise of Off-State Voltage ( $V_D = \text{Rated } V_{\text{DRM}}, \text{Exponential Voltage Rise, Gate Open}, T_C = 100^\circ\text{C}$ )	$di/dt$	60	–	–	$\text{A}/\mu\text{s}$

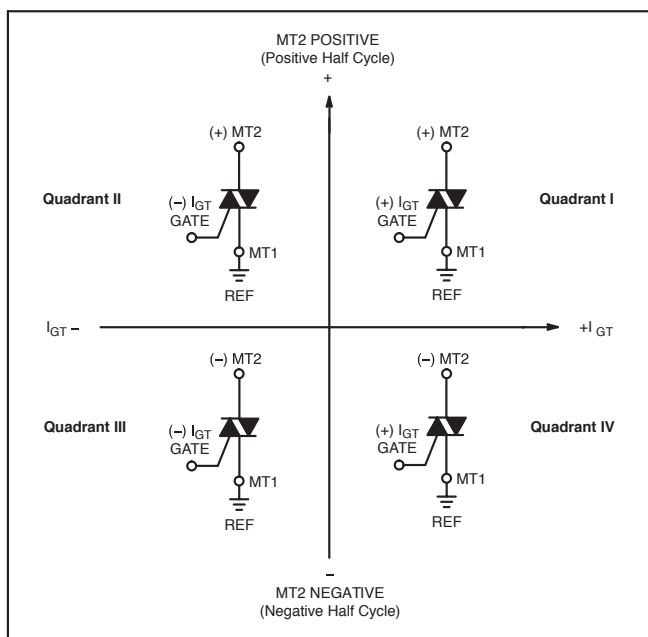
2. Pulse Test: Pulse Width  $\leq 2.0 \text{ ms}$ , Duty Cycle  $\leq 2\%$ .

### Voltage Current Characteristic of SCR

Symbol	Parameter
$V_{DRM}$	Peak Repetitive Forward Off State Voltage
$I_{DRM}$	Peak Forward Blocking Current
$V_{RRM}$	Peak Repetitive Reverse Off State Voltage
$I_{RRM}$	Peak Reverse Blocking Current
$V_{TM}$	Maximum On State Voltage
$I_H$	Holding Current



### Quadrant Definitions for a Triac



All polarities are referenced to MT1.  
With in-phase signals (using standard AC lines) quadrants I and III are used.

Figure 1. Current Derating

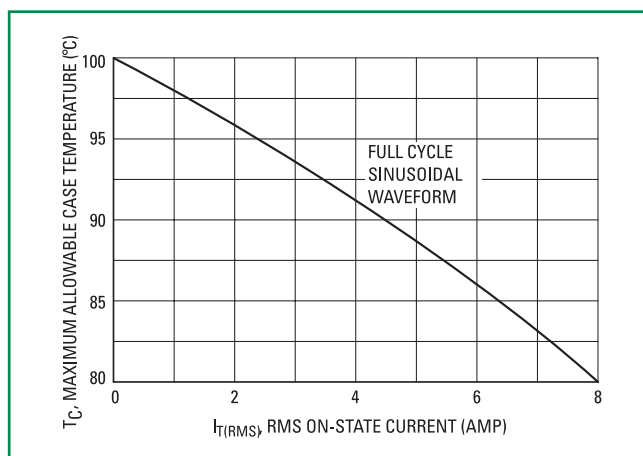
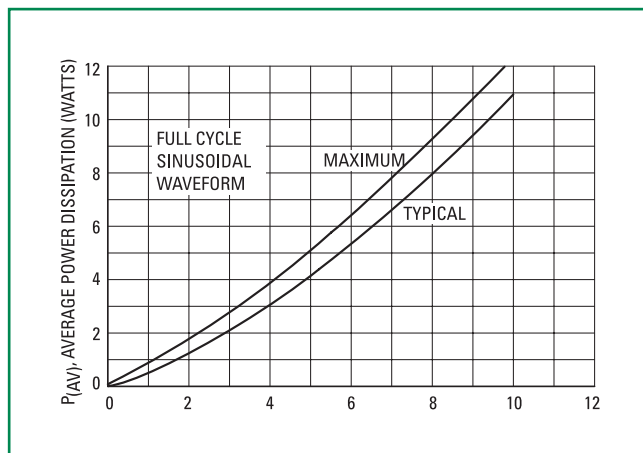
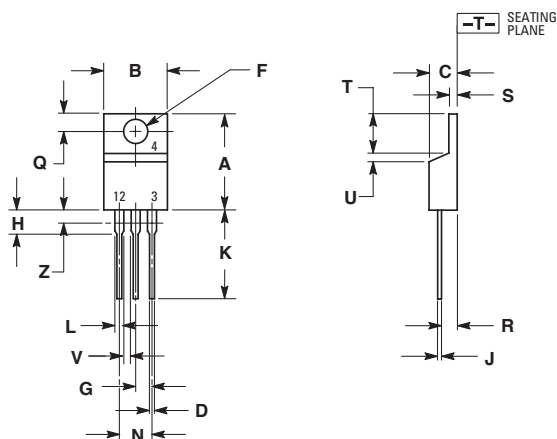


Figure 2. Power Dissipation



### Dimensions

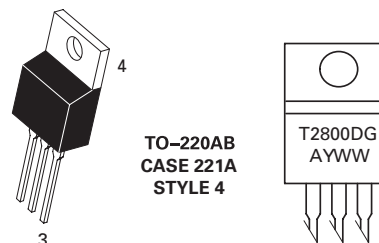


Dim	Inches		Millimeters	
	Min	Max	Min	Max
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.014	0.022	0.36	0.55
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

2. CONTROLLING DIMENSION: INCH.

### Part Marking System



A= Assembly Location  
Y= Year  
WW = Work Week  
G = Pb-Free Package

### Pin Assignment

1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

### Ordering Information

Device	Package	Shipping
T2800D	TO220AB	500 Units/Box
T2800DG	TO220AB (Pb-Free)	

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